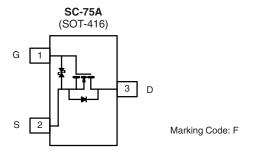




## N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY							
V <sub>DS(min.)</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	V <sub>GS(th)</sub> (V)	I <sub>D</sub> (mA)				
60	1.25 at V <sub>GS</sub> = 10 V	1 to 2.5	330				



Ordering Information: Si1022R-T1-E3 (Lead (Pb)-free)

Si1022R-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

 Halogen-free According to IEC 61249-2-21 Definition

TrenchFET<sup>®</sup> Power MOSFETs

• Low On-Resistance: 1.25  $\Omega$ 

Low Threshold: 2.5 V

Low Input Capacitance: 30 pFFast Switching Speed: 25 ns

· Low Input and Output Leakage

Miniature Package

ESD Protected: 2000 V

• Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- · Battery Operated Systems
- · Solid State Relays

#### **BENEFITS**

- · Low Offset Voltage
- Low-Voltage Operation
- · High-Speed Circuits
- Low Error Voltage
- Small Board Area

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted								
Parameter		Symbol	Limit	Unit				
Drain-Source Voltage		V <sub>DS</sub>	60	V				
Gate-Source Voltage		V <sub>GS</sub>	± 20					
O anti-	T <sub>A</sub> = 25 °C	I-	330	mA				
Continuous Drain Current <sup>a</sup>	T <sub>A</sub> = 85 °C	- I <sub>D</sub>	240					
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	650					
Davisa Dissipation	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	250	mW				
Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C	, п	130					
Thermal Resistance, Maximum Junction-to-Ambient <sup>a</sup>		R <sub>thJA</sub>	500	°C/W				
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C				

### Notes:

a. Surface mounted on FR4 board, power applied for  $t \le 10 \text{ s}$ .



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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted									
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static		•							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 10 \mu\text{A}$	60			V			
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 0.25 \text{ mA}$	1		2.5	V			
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			± 150				
Gate-Body Leakage	I <sub>GSS</sub>	T <sub>J</sub> = 85 °C			± 500				
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$ ±		± 20	nA			
	I <sub>DSS</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V			10				
Zero Gate Voltage Drain Current		T <sub>J</sub> = 85 °C			100				
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}$	500			mA			
On-State Drain Current		$V_{DS} = 7.5 \text{ V}, V_{GS} = 10 \text{ V}$	800			] "			
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 200 \text{ mA}$			3.0				
Dunin Course On Otata Basistanas		T <sub>J</sub> = 125 °C			5.0	Ω			
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$			1.25	52			
		T <sub>J</sub> = 125 °C			2.25				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 200 \text{ mA}$	100			mS			
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$V_{GS} = 0 \text{ V}, I_{S} = 200 \text{ mA}$			1.3	V			
Dynamic <sup>b</sup>									
Input Capacitance	C <sub>iss</sub>			30					
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		6		pF			
Reverse Transfer Capacitance	C <sub>rss</sub>			2.5					
Gate Charge	Q <sub>g</sub>	$V_{DS} = 10 \text{ V}, I_D = 250 \text{ mA}, V_{GS} = 4.5 \text{ V}$			0.6	nC			
Switching <sup>b, c</sup>									
Turn-On Time	t <sub>(on)</sub>	$V_{DD} = 30 \text{ V}, R_{L} = 150 \Omega,$			25	ns			
Turn-Off Time	t <sub>(off)</sub>	$I_D = 200 \text{ mA}, V_{GEN} = 10 \text{ V}, R_g = 10 \Omega$			35	113			

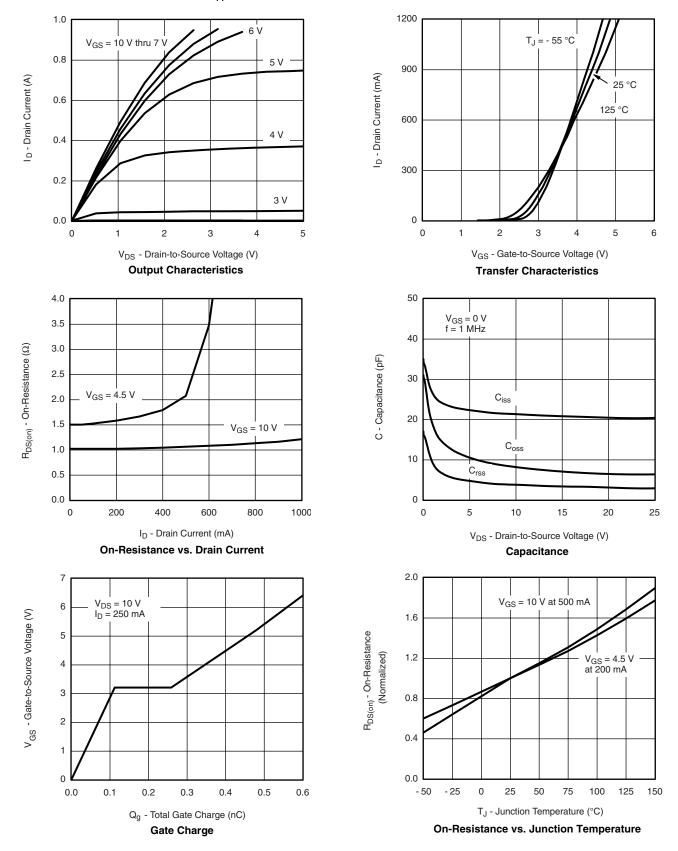
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



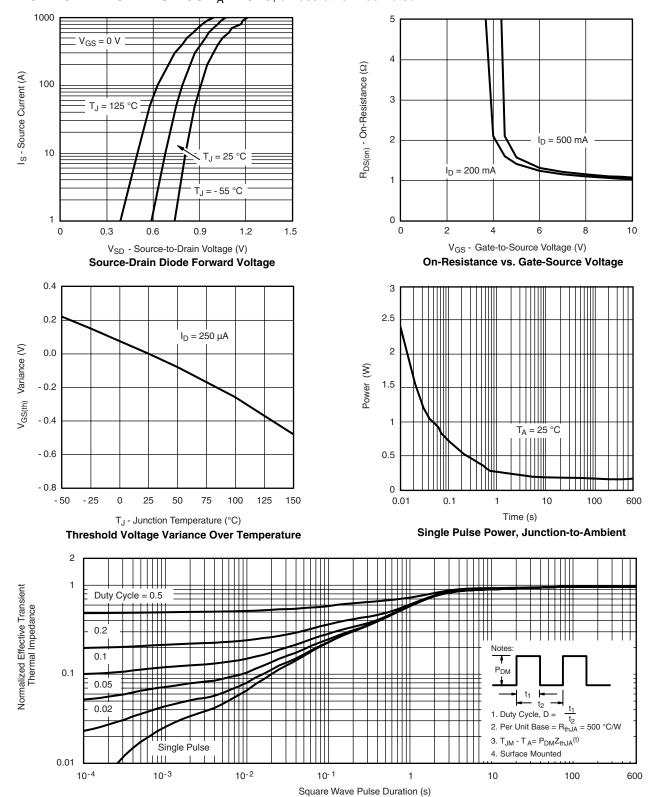
## TYPICAL CHARACTERISTICS T<sub>A</sub> = 25 °C, unless otherwise noted



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### **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?71331">www.vishay.com/ppg?71331</a>.



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